

SEMIPACK[®] 3

Thyristor / Diode Modules

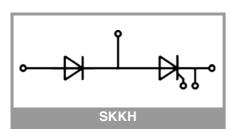
SKKH 280/22 E H4

Features

- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- Precious metal pressure contacts for high reliability
- Thyristor with amplifying gate
- UL recognized, file no. E 63 532

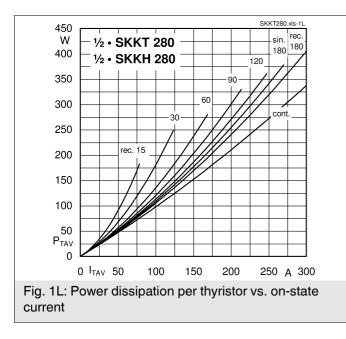
Typical Applications*

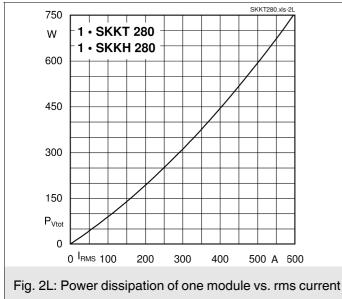
- DC motor control (e. g. for machine tools)
- AC motor starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

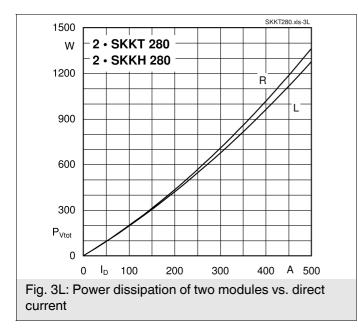


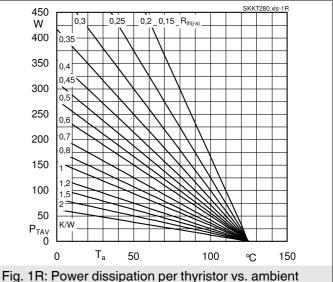
| Absolute | e Maximum Rating | S | | | |
|-----------------------|-------------------------|-------------------------|---------|------------------|--|
| Symbol | Conditions | | Values | Unit | |
| Chip | | | | | |
| I _{T(AV)} | sinus 180° | T _c = 85 °C | 252 | А | |
| | | T _c = 79 °C | 280 | А | |
| I _{TRMS} | continuous operation | | 440 | А | |
| I _{TSM} | 10 ms | T _j = 25 °C | 8500 | Α | |
| | | T _j = 125 °C | 7500 | А | |
| i ² t | 10 ms | T _j = 25 °C | 361250 | A ² s | |
| | | T _j = 125 °C | 281250 | A²s | |
| V _{RSM} | | | 2300 | V | |
| V _{RRM} | | | 2200 | V | |
| V _{DRM} | | | 2200 | V | |
| (di/dt) _{cr} | T _j = 125 °C | | 250 | A/µs | |
| (dv/dt) _{cr} | T _j = 125 °C | | 1000 | V/µs | |
| Tj | | | -40 125 | °C | |
| Module | | | | | |
| T _{stg} | | | -40 125 | °C | |
| V _{isol} | a.c.; 50 Hz; r.m.s. | 1 min | 4000 | V | |
| | | 1 s | 4800 | V | |

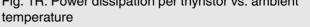
| Characte | | | 1 | | | |
|----------------------------------|--|------------|------|------|----------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Chip | | | | | | |
| V _T | $T_j = 25 \ ^{\circ}C, I_T =$ | | | 1.55 | V | |
| V _{T(TO)} | T _j = 125 °C | | | | 0.9 | V |
| r _T | T _j = 125 °C | | | 0.75 | mΩ | |
| I _{DD} ;I _{RD} | $T_j = 125 \text{ °C}, V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$ | | | | 90 | mA |
| t _{gd} | $T_j = 25 \text{ °C}, I_G = 1 \text{ A}, di_G/dt = 1 \text{ A}/\mu \text{s}$ | | | 1 | | μs |
| t _{gr} | $V_{\rm D} = 0.67 * V_{\rm DRM}$ | | | 2 | | μs |
| t _q | T _j = 125 °C | | 50 | 150 | 150 | μs |
| I _H | T _j = 25 °C | | | 150 | 500 | mA |
| IL | $T_{j} = 25 \text{ °C}, R_{G} = 33 \Omega$ | | | 300 | 2000 | mA |
| V _{GT} | T _j = 25 °C, d.c. | | 3 | | | V |
| I _{GT} | T _j = 25 °C, d.c. | | 200 | | | mA |
| V_{GD} | T _j = 125 °C, d.c. | | | | 0.25 | V |
| I _{GD} | T _j = 125 °C, d.c. | | | | 10 | mA |
| R _{th(j-c)} | cont. | per chip | | | 0.11 | K/W |
| | | per module | | | 0.055 | K/W |
| R _{th(j-c)} | sin. 180° | per chip | | | 0.116 | K/W |
| | | per module | | | 0.058 | K/W |
| R _{th(j-c)} | rec. 120° | per chip | | | 0.13 | K/W |
| | | per module | | | 0.065 | K/W |
| Module | | | | | | |
| R _{th(c-s)} | chip | | | 0.04 | | K/W |
| | module | | | 0.02 | | K/W |
| Ms | to heatsink M5 | | 4.25 | | 5.75 | Nm |
| Mt | to terminals M8 | 3 | 7.65 | | 10.34 | Nm |
| a | | | | | 5 * 9,81 | m/s² |
| w | | | | 600 | | g |

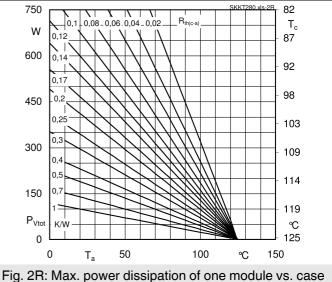


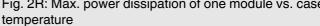


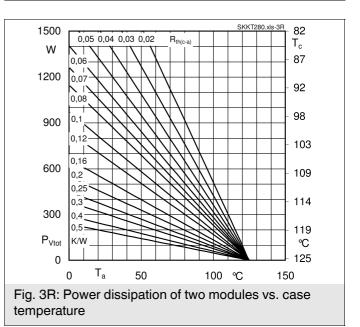


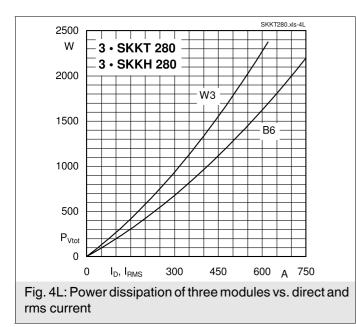


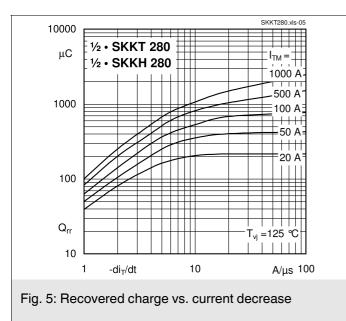


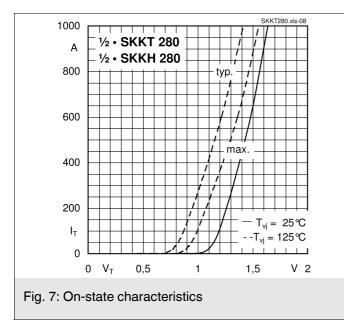


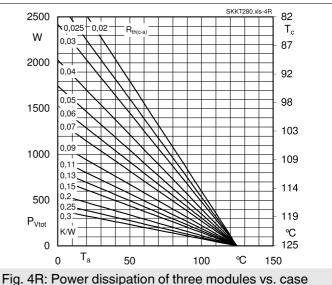


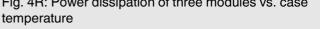


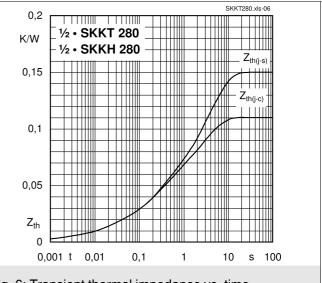


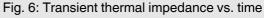


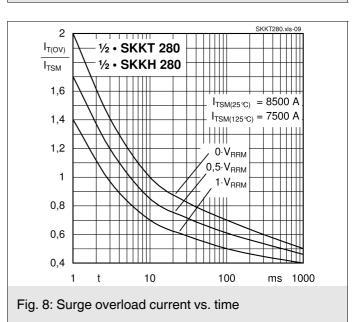


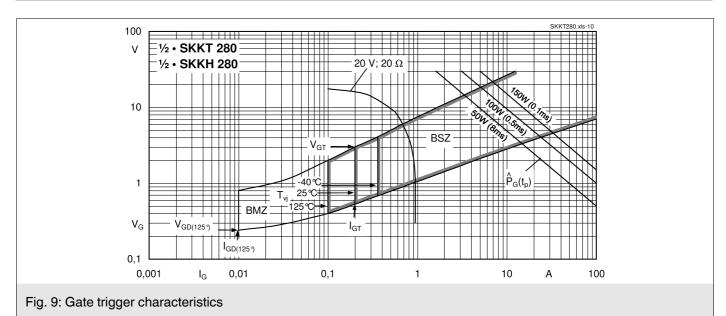


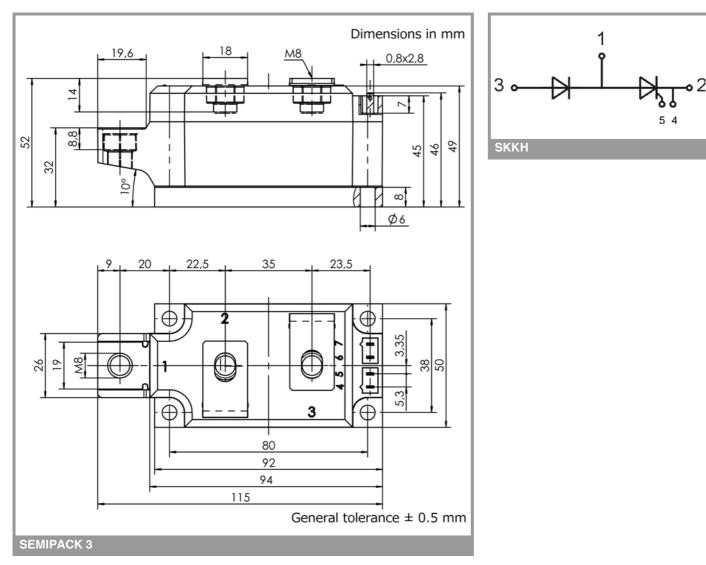












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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